

CMOS Low Voltage 4 Ω , 4-Channel Multiplexer

ADG704

FEATURES

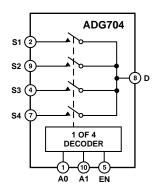
+1.8 V to +5.5 V Single Supply 2.5 Ω (Typ) On Resistance Low On-Resistance Flatness -3 dB Bandwidth >200 MHz Rail-to-Rail Operation 10-Lead μ SOIC Package Fast Switching Times t_{ON} 20 ns t_{OFF} 13 ns

Typical Power Consumption (<0.01 µW)

APPLICATIONS
Battery Powered Systems
Communication Systems
Sample-and-Hold Systems
Audio Signal Routing
Data Acquisition System

TTL/CMOS Compatible

FUNCTIONAL BLOCK DIAGRAM



GENERAL DESCRIPTION

Video Switching

The ADG704 is a CMOS analog multiplexer, comprising four single channels. This multiplexer is designed on an advanced submicron process that provides low power dissipation yet gives high switching speed, low on resistance, low leakage currents and high bandwidths.

The on resistance profile is very flat over the full analog signal range. This ensures excellent linearity and low distortion when switching audio signals. Fast switching speed also makes the part suitable for video signal switching.

The ADG704 can operate from a single supply range of +1.8 V to +5.5 V, making it ideal for use in battery powered instruments and with the new generation of DACs and ADCs from Analog Devices.

The ADG704 switches one of four inputs to a common output, D, as determined by the 3-bit binary address lines, A0, A1 and EN. A Logic "0" on the EN pin disables the device.

Each switch of the ADG704 conducts equally well in both directions when ON. The ADG704 exhibits break-before-make switching action.

The ADG704 is available in 10-lead $\mu SOIC$ package.

PRODUCT HIGHLIGHTS

- 1. +1.8 V to +5.5 V Single Supply Operation.
 The ADG704 offers high performance and is fully specified and guaranteed with +3 V and +5 V supply rails.
- 2. Very Low R_{ON} (4.5 Ω Max at 5 V, 8 Ω Max at 3 V). At supply voltage of +1.8 V, R_{ON} is typically 35 Ω over the temperature range.
- 3. Low On-Resistance Flatness.
- 4. -3 dB Bandwidth Greater than 200 MHz.
- Low Power Dissipation. CMOS construction ensures low power dissipation.
- 6. Fast t_{ON}/t_{OFF} .
- 7. Break-Before-Make Switching Action.
- 8. 10-Lead µSOIC Package.

REV. A

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$\label{eq:continuous} \textbf{ADG704-SPECIFICATIONS}^{1} \ \ \substack{(V_{DD} \,=\, +5\ V\,\pm\,10\%,\ \text{GND}\,=\, 0\ V.\ \text{All Specifications}\, -40^{\circ}\text{C to}\, +85^{\circ}\text{C, unless}} \\ \text{otherwise noted.})$

| | B Version -40°C to | | | | |
|--|-----------------------|--------------------------|------------------|---|--|
| Parameter | +25°C | +85°C | Units | Test Conditions/Comments | |
| ANALOG SWITCH | | | | | |
| Analog Signal Range | | $0~V~to~V_{\mathrm{DD}}$ | V | | |
| On-Resistance (R _{ON}) | 2.5 | | Ω typ | $V_S = 0 \text{ V to } V_{DD}, I_{DS} = -10 \text{ mA};$ | |
| | 4 | 4.5 | Ω max | Test Circuit 1 | |
| On-Resistance Match Between | | | | | |
| Channels (ΔR_{ON}) | | 0.1 | Ω typ | $V_S = 0 \text{ V to } V_{DD}, I_{DS} = -10 \text{ mA}$ | |
| | | 0.4 | Ω max | | |
| On-Resistance Flatness (R _{FLAT(ON)}) | 0.75 | | Ω typ | $V_S = 0 \text{ V to } V_{DD}, I_{DS} = -10 \text{ mA}$ | |
| | | 1.2 | Ω max | | |
| LEAKAGE CURRENTS | | | | $V_{\rm DD} = +5.5 \text{ V}$ | |
| Source OFF Leakage I _S (OFF) | ±0.01 | | nA typ | $V_S = 4.5 \text{ V/1 V}, V_D = 1 \text{ V/4.5 V};$ | |
| Source of 1 Leanings 15 (Of 1) | ±0.1 | ±0.3 | nA max | Test Circuit 2 | |
| Drain OFF Leakage I _D (OFF) | ±0.01 | ±0.5 | nA typ | $V_S = 4.5 \text{ V/1 V}, V_D = 1 \text{ V/4.5 V};$ | |
| Diam off Zeamage in (off) | ±0.1 | ±0.3 | nA max | Test Circuit 2 | |
| Channel ON Leakage ID, IS (ON) | ±0.01 | _ 0.3 | nA typ | $V_S = V_D = 4.5 \text{ V or } 1 \text{ V};$ | |
| Citation Civ Denning 1 _D , 1 ₃ (Civ) | ±0.1 | ±0.3 | nA max | Test Circuit 3 | |
| DIGITAL DIDITIO | | | | | |
| DIGITAL INPUTS | | 2.4 | | | |
| Input High Voltage, V _{INH} | | 2.4 | V min | | |
| Input Low Voltage, V _{INL} | | 0.8 | V max | | |
| Input Current | 0.005 | | | X7 - X7 X7 | |
| I _{INL} or I _{INH} | 0.005 | ±0.1 | μA typ | $V_{IN} = V_{INL} \text{ or } V_{INH}$ | |
| | | ±0.1 | μA max | | |
| DYNAMIC CHARACTERISTICS ² | | | | | |
| t_{ON} | 14 | | ns typ | $R_L = 300 \Omega, C_L = 35 pF$ | |
| | | 20 | ns max | $V_S = 3 V$, Test Circuit 4 | |
| $t_{ m OFF}$ | 6 | | ns typ | $R_L = 300 \Omega, C_L = 35 pF$ | |
| | _ | 13 | ns max | $V_S = 3 \text{ V}$, Test Circuit 4 | |
| Break-Before-Make Time Delay, t _D | 8 | | ns typ | $R_{L} = 300 \Omega, C_{L} = 35 pF$ | |
| | | 1 | ns min | $V_{S1} = V_{S2} = 3 \text{ V}$, Test Circuit 5 | |
| Charge Injection | 3 | | pC typ | $V_S = 2 \text{ V}, R_S = 0 \Omega, C_L = 1 \text{ nF};$ | |
| 007 13 | 60 | | 170 | Test Circuit 6 | |
| Off Isolation | -60 | | dB typ | $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$ | |
| | -80 | | dB typ | $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; | |
| Channel to Channel Court | 60 | | 4D 4 | Test Circuit 7 | |
| Channel-to-Channel Crosstalk | -62 82 | | dB typ | $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$ $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; | |
| | -82 | | dB typ | | |
| Bandwidth –3 dB | 200 | | МЦз | Test Circuit 8 | |
| C _S (OFF) | 200 | | MHz typ | $R_L = 50 \Omega$, $C_L = 5 pF$; Test Circuit 9 | |
| $C_{S}(OFF)$ $C_{D}(OFF)$ | 37 | | pF typ pF typ | | |
| C_D (OFF) C_D , C_S (ON) | 54 | | pF typ | | |
| |)4 | | pr typ | | |
| POWER REQUIREMENTS | | | | $V_{DD} = +5.5 \text{ V}$ | |
| _ | | | | Digital Inputs = 0 V or 5 V | |
| I_{DD} | 0.001 | | μA typ | | |
| | | 1.0 | μA max | | |

Specifications subject to change without notice.

REV. A -2-

NOTES ¹Temperature ranges are as follows: B Version: -40°C to +85°C.

²Guaranteed by design, not subject to production test.

 $\textbf{SPECIFICATIONS}^{1} \text{ (V}_{DD} = +3 \text{ V} \pm 10\%, \text{ GND} = 0 \text{ V}. \text{ All Specifications} -40^{\circ}\text{C to} +85^{\circ}\text{C}, \text{ unless otherwise noted.)}$

| | B Version | | | |
|---|---------------|-------------------------|------------------|--|
| Parameter | +25°C | -40°C to +85°C | Units | Test Conditions/Comments |
| ANALOG SWITCH | | | | |
| Analog Signal Range | | 0 V to V_{DD} | V | |
| On-Resistance (R _{ON}) | 4.5 | 5 | Ω typ | $V_S = 0 \text{ V to } V_{DD}, I_{DS} = -10 \text{ mA};$ |
| (010 | | 8 | Ω max | Test Circuit 1 |
| On-Resistance Match Between | | | | |
| Channels (ΔR_{ON}) | 0.1 | | Ω typ | $V_S = 0 \text{ V to } V_{DD}, I_{DS} = -10 \text{ mA}$ |
| | | 0.4 | Ω max | <i>BB</i> , <i>B</i> |
| On-Resistance Flatness (R _{FLAT(ON)}) | | 2.5 | Ω typ | $V_S = 0 \text{ V to } V_{DD}, I_{DS} = -10 \text{ mA}$ |
| LEAKAGE CURRENTS | | | | $V_{\rm DD} = +3.3 \text{ V}$ |
| Source OFF Leakage I _S (OFF) | ±0.01 | | nA typ | $V_{S} = 3 \text{ V/1 V}, V_{D} = 1 \text{ V/3 V};$ |
| Source Of T Leakage Is (OTT) | ±0.01 | ±0.3 | nA max | Test Circuit 2 |
| Drain OFF Leakage I _D (OFF) | ±0.1 ±0.01 | ±0.5 | nA typ | $V_S = 3 \text{ V/1 V}, V_D = 1 \text{ V/3 V};$ |
| Diani Off Leakage ID (Off) | ±0.01 | ±0.3 | nA typ | $V_S = 3 V/1 V, V_D = 1 V/3 V,$ Test Circuit 2 |
| Channel ON Leakage I I (ON) | ±0.1 ±0.01 | ±0.9 | | $V_S = V_D = 3 \text{ V or } 1 \text{ V};$ |
| Channel ON Leakage I _D , I _S (ON) | ±0.01 ±0.1 | ±0.3 | nA typ nA max | $V_S - V_D - 3 V \text{ of } 1 V;$ Test Circuit 3 |
| | ±0.1 | ±0.3 | па шах | 1 est Gircuit 3 |
| DIGITAL INPUTS | | | | |
| Input High Voltage, V _{INH} | | 2.0 | V min | |
| Input Low Voltage, V _{INL} | | 0.4 | V max | |
| Input Current | | | | |
| I_{INL} or I_{INH} | 0.005 | | μA typ | $V_{IN} = V_{INL}$ or V_{INH} |
| | | ±0.1 | μA max | |
| DYNAMIC CHARACTERISTICS ² | | | | |
| t_{ON} | 16 | | ns typ | $R_{L} = 300 \Omega, C_{L} = 35 pF$ |
| | | 24 | ns max | $V_S = 2 \text{ V}$, Test Circuit 4 |
| $t_{ m OFF}$ | 8 | | ns typ | $R_{L} = 300 \Omega, C_{L} = 35 pF$ |
| 011 | | 16 | ns max | $V_S = 2 \text{ V}$, Test Circuit 4 |
| Break-Before-Make Time Delay, t _D | 9 | | ns typ | $R_{L} = 300 \Omega, C_{L} = 35 pF$ |
| ••• • | | 1 | ns min | $V_{S1} = V_{S2} = 2 \text{ V}$, Test Circuit 5 |
| Charge Injection | 3 | | pC typ | $V_S = 1.5 \text{ V}, R_S = 0 \Omega, C_L = 1 \text{ nF};$ |
| , | | | 1 01 | Test Circuit 6 |
| Off Isolation | -60 | | dB typ | $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$ |
| | -80 | | dB typ | $R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; |
| | | | | Test Circuit 7 |
| Channel-to-Channel Crosstalk | -62 | | dB typ | $R_L = 50 \Omega, C_L = 5 pF, f = 10 MHz$ |
| | -82 | | dB typ | $R_L = 50 \Omega, C_L = 5 \text{ pF, f} = 1 \text{ MHz;}$ |
| | | | | Test Circuit 8 |
| Bandwidth -3 dB | 200 | | MHz typ | $R_L = 50 \Omega$, $C_L = 5 pF$; Test Circuit 9 |
| C_{S} (OFF) | 9 | | pF typ | |
| $C_{\rm D}$ (OFF) | 37 | | pF typ | |
| $C_D, C_S(ON)$ | 54 | | pF typ | |
| POWER REQUIREMENTS | | | - | $V_{\rm DD} = +3.3 \text{ V}$ |
| TOWER REQUIREMENTS | | | | Digital Inputs = 0 V or 3 V |
| - | 0.001 | | μA typ | Digital Inputs – 0 v 01 5 v |
| $I_{ m DD}$ | | | | |

REV. A -3-

NOTES ¹Temperature ranges are as follows: B Version: -40°C to +85°C.

²Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

ADG704

ABSOLUTE MAXIMUM RATINGS¹

 $(T_A = +25^{\circ}C \text{ unless otherwise noted})$

| (1 _A - +23 C unless otherwise noted) |
|--|
| V_{DD} to GND0.3 V to +6 V |
| Analog, Digital Inputs ² -0.3 V to V_{DD} +0.3 V or |
| 30 mA, Whichever Occurs First |
| Continuous Current, S or D |
| Peak Current, S or D |
| (Pulsed at 1 ms, 10% Duty Cycle Max) |
| Operating Temperature Range |
| Industrial (B Version)40°C to +85°C |
| Storage Temperature Range65°C to +150°C |
| Junction Temperature +150°C |
| μSOIC Package, Power Dissipation |
| θ_{JA} Thermal Impedance |
| Lead Temperature, Soldering |
| Vapor Phase (60 sec)+215°C |
| Infrared (15 sec) +220°C |
| |

NOTES

¹Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

²Overvoltages at IN, S or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

ORDERING GUIDE

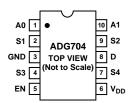
| Model | Temperature Range | Brand ¹ | Package Option ² |
|-----------|----------------------|--------------------|--------------------------------|
| ADG704BRM | −40°C to +85°C | S9B | RM-10 |

NOTES

¹Brand = Due to small package size, these three characters represent the part number.

 ${}^{2}RM = \mu SOIC.$

PIN CONFIGURATION (10-Lead μSOIC)



TERMINOLOGY

| TERMINOLOG | Ϋ́ |
|-----------------------|---|
| $V_{ m DD}$ | Most positive power supply potential. |
| GND | Ground (0 V) reference. |
| S | Source terminal. May be an input or output. |
| D | Drain terminal. May be an input or output. |
| A0, A1 | Logic control inputs. |
| EN | Logic control input. |
| R_{ON} | Ohmic resistance between D and S. |
| $\Delta R_{ m ON}$ | On resistance match between any two channels i.e., $R_{\rm ON}$ max $-R_{\rm ON}$ min. |
| R _{FLAT(ON)} | Flatness is defined as the difference between the maximum and minimum value of on resis- tance as measured over the specified analog signal range. |
| I _D (OFF) | Drain leakage current with the switch "OFF." |
| I _S (OFF) | Source leakage current with the switch "OFF." |
| $I_D, I_S (ON)$ | Channel leakage current with the switch "ON." |
| $V_{D}(V_{S})$ | Analog voltage on terminals D, S. |
| C_{S} (OFF) | "OFF" switch source capacitance. |
| C_D (OFF) | "OFF" switch drain capacitance. |
| C_D , C_S (ON) | "ON" switch capacitance. |
| t_{ON} | Delay between applying the digital control input and the output switching on. See Test Circuit 4. |
| t _{OFF} | Delay between applying the digital control input and the output switching off. |
| t_D | "OFF" time or "ON" time measured between the 90% points of both switches, when switching from one address state to another. See Test Circuit 5. |
| Crosstalk | A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance. |
| Off Isolation | A measure of unwanted signal coupling through an "OFF" switch. |
| Charge Injection | A measure of the glitch impulse transferred from the digital input to the analog output during switching. |
| Bandwidth | The frequency at which the output is attenuated by –3 dBs. |
| On Response | The frequency response of the "ON" switch. |
| On Loss | The voltage drop across the "ON" switch, seen on the On Response vs. Frequency plot as how many dBs the signal is away from 0 dB at very low frequencies. |

Table I. Truth Table

| A1 | A0 | EN | ON Switch |
|----|----|----|-----------|
| X | X | 0 | NONE |
| 0 | 0 | 1 | 1 |
| 0 | 1 | 1 | 2 |
| 1 | 0 | 1 | 3 |
| 1 | 1 | 1 | 4 |

CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG704 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



Typical Performance Characteristics—ADG704

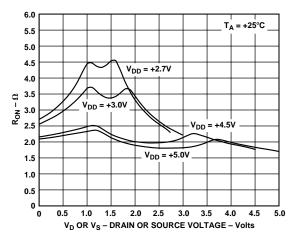


Figure 1. On Resistance as a Function of V_D (V_S) Single Supplies

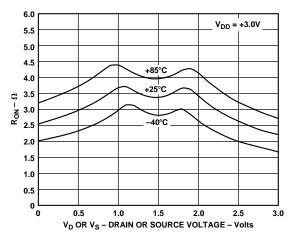


Figure 2. On Resistance as a Function of V_D (V_S) for Different Temperatures; $V_{DD} = 3 \text{ V}$

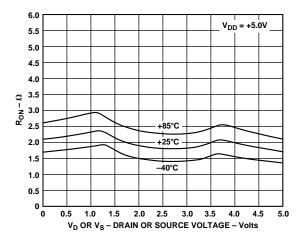


Figure 3. On Resistance as a Function of V_D (V_S) for Different Temperatures; $V_{DD} = 5 \ V$

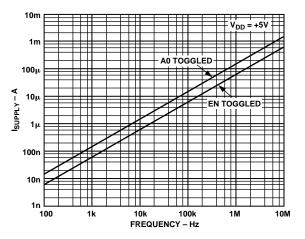


Figure 4. Supply Current vs. Input Switching Frequency

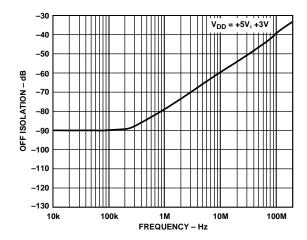


Figure 5. Off Isolation vs. Frequency

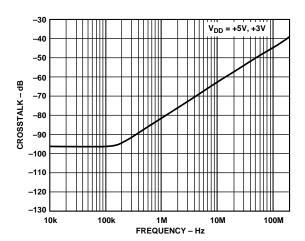


Figure 6. Crosstalk vs. Frequency

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ADG704

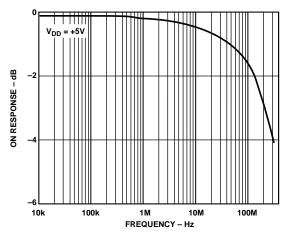


Figure 7. On Response vs. Frequency

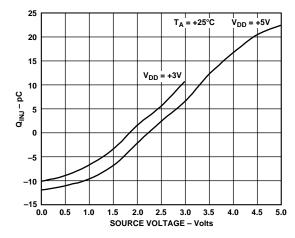


Figure 8. Charge Injection vs. Source Voltage

APPLICATIONS

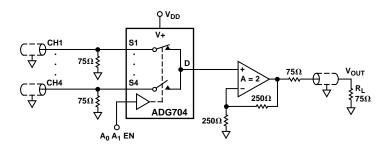
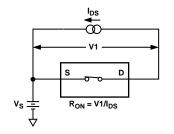


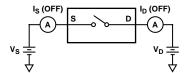
Figure 9. 4-Channel Video Multiplexing

-6-

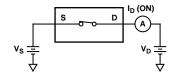
Test Circuits



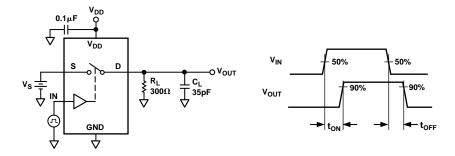
Test Circuit 1. On Resistance



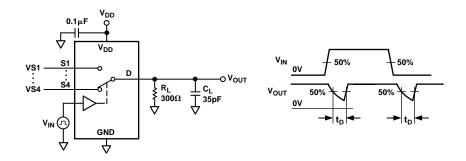
Test Circuit 2. Off Leakage



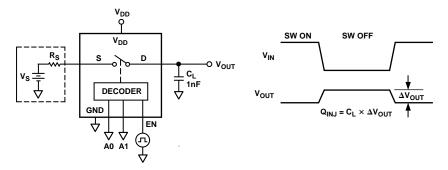
Test Circuit 3. On Leakage



Test Circuit 4. Switching Times

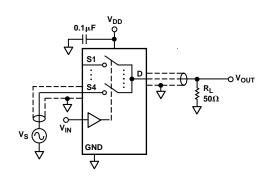


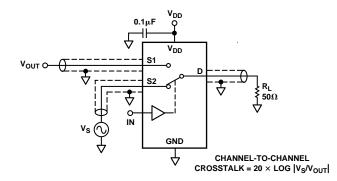
Test Circuit 5. Break-Before-Make Time Delay, t_D



Test Circuit 6. Charge Injection

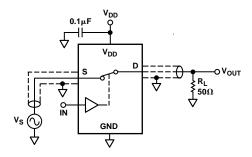
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Test Circuit 7. Off Isolation

Test Circuit 8. Channel-to-Channel Crosstalk



Test Circuit 9. Bandwidth

OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).

10-Lead μSOIC (RM-10)

